

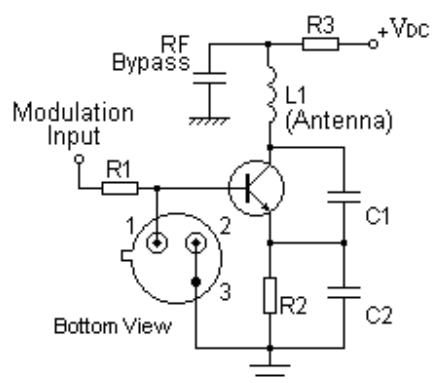
## Features

- 1-port Resonator
- Metal Case for **TO-39**
- **RoHS** compatible
- Package Code TO-39
- Electrostatic Sensitive Device(ESD)

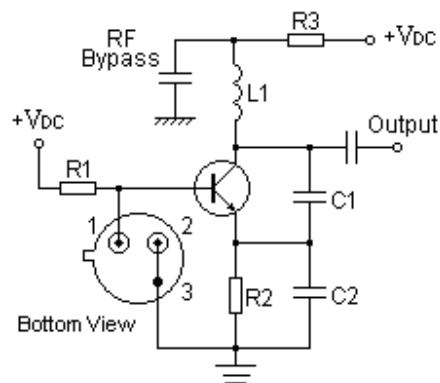


## Application

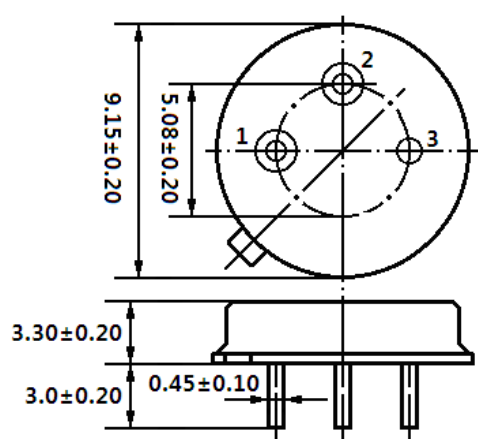
### Typical Low-Power Transmitter Application



### Typical Local Oscillator Application



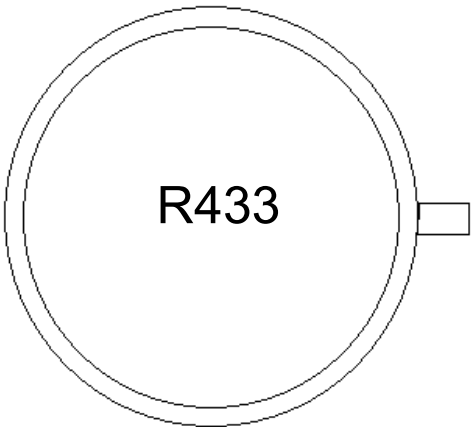
## Package Dimensions (TO-39)



## Pin Configuration

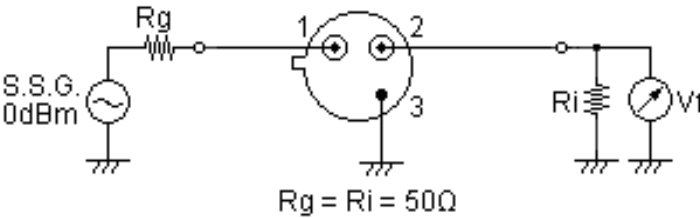
|   |               |
|---|---------------|
| 1 | Input/ Output |
| 2 | Output/ Input |
| 3 | Ground        |

Marking

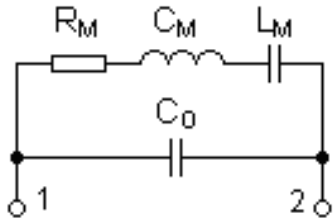


|     |                                |
|-----|--------------------------------|
| R   | Manufacturer&<br>SAW Resonator |
| 433 | Part number                    |

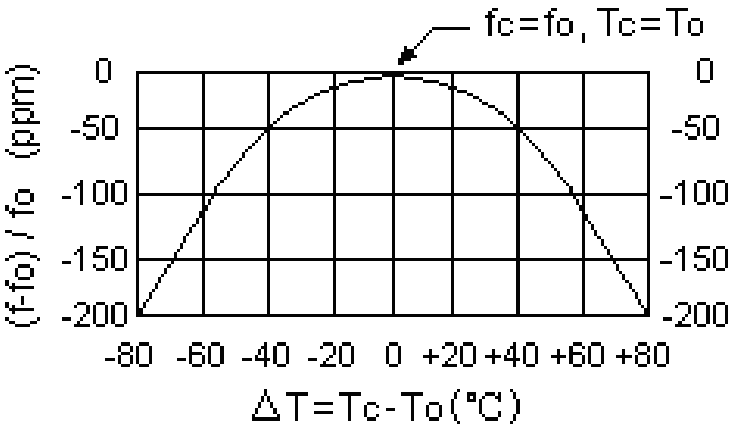
Test Circuit



Equivalent LC Model



Temperature Characteristics



The curve shown above accounts for resonator contribution only and does not include LC component temperature contributions.

## Performance

### Maximum Rating

| Item                  |           | Value      | Unit |
|-----------------------|-----------|------------|------|
| DC Voltage            | $V_{DC}$  | $\pm 30$   | V    |
| Operation Temperature | T         | -40 ~ +85  | °C   |
| Storage Temperature   | $T_{stg}$ | -55 ~ +125 | °C   |
| RF Power Dissipation  | P         | 10         | dBm  |

### Electronic Characteristics

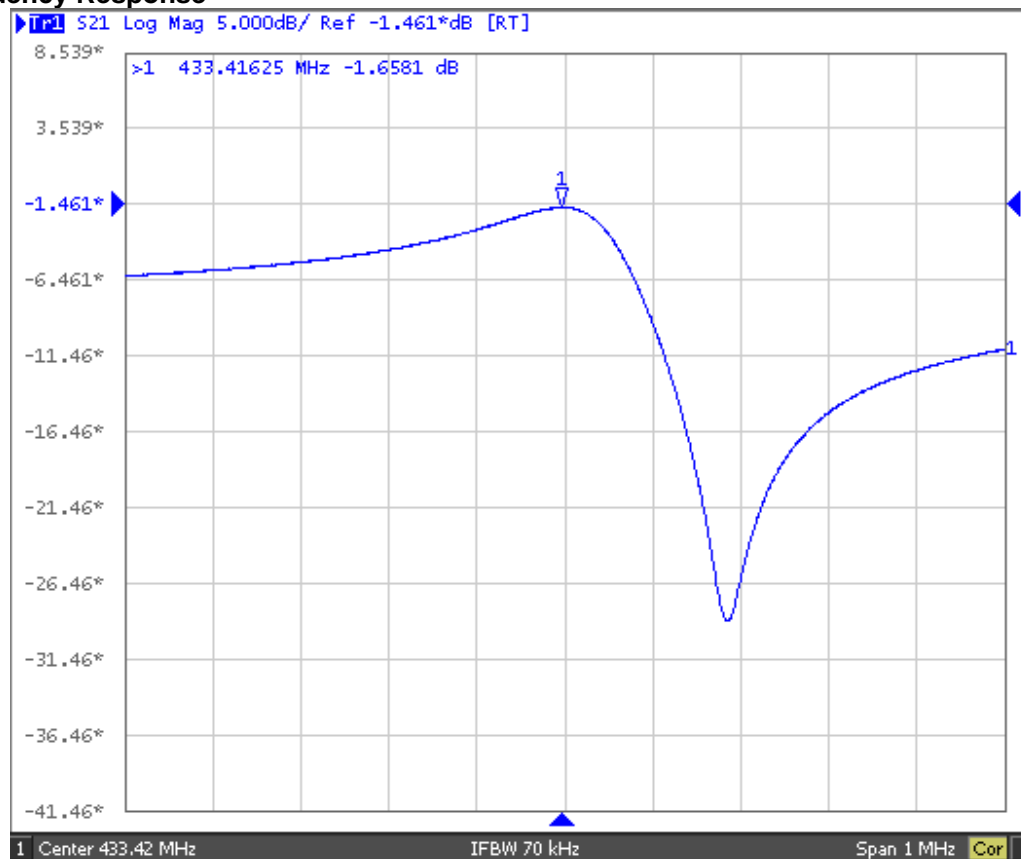
Test Temperature:  $25^{\circ}\text{C} \pm 2^{\circ}\text{C}$

Terminating source impedance:  $50\Omega$

Terminating load impedance:  $50\Omega$

| Item  |                                      |              | Minimum | Typical   | Maximum | Unit          |
|---|--------------------------------------|--------------|---------|-----------|---------|---------------|
| Center Frequency                              | Absolute Frequency                   | $f_c$        |         | 433.42    |         | MHz           |
|   | Tolerance from 303.875MHz            | $\Delta f_c$ |         | $\pm 75$  |         | KHz           |
| Insertion Loss(min)                           |                                      | IL           |         | 1.5       | 2.0     | dB            |
| Quality Factor                                | Unloaded Q                           | $Q_U$        |         | 16689     |         |               |
|   | 50 $\Omega$ Loaded Q                 | $Q_L$        |         | 1965      |         |               |
| Temperature Stability                         | Turnover Temperature                 | $T_0$        | 25      | 40        | 55      | °C            |
|   | Frequency Temperature Coefficient    | FTC          |         | 0.032     |         | ppm/°C        |
| Frequency Aging                               | Absolute Value during the First Year | $ f_A $      |         | $\leq 10$ |         | ppm/yr        |
| DC Insulation Resistance between Any Two Pins |                                      |              | 1.0     |           |         | M $\Omega$    |
| RF Equivalent RLC Model                       | Motional Resistance                  | $R_M$        |         | 13.5      | 16.0    | $\Omega$      |
|   | Motional Inductance                  | $L_M$        |         | 81.86     |         | $\mu\text{H}$ |
|   | Motional Capacitance                 | $C_M$        |         | 1.64      |         | fF            |
|   | Static Capacitance                   | $C_0$        | 3.2     | 3.4       | 3.6     | pF            |

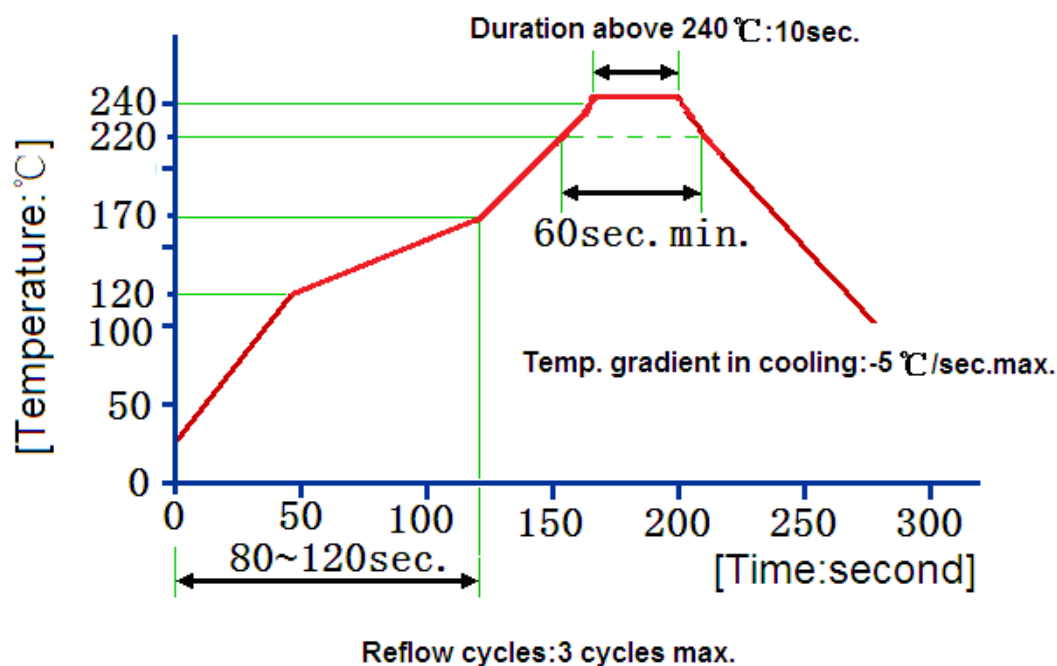
## Frequency Response



## Reliability (The SAW components shall remain electrical performance after tests)

| No. | Test item                    | Test condition  |
|-----|------------------------------|---|
| 1   | Temperature Storage          | (1) Temperature: $85^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , Duration: 250h , Recovery time: $2\text{h} \pm 0.5\text{h}$<br>(2) Temperature: $-40^{\circ}\text{C} \pm 3^{\circ}\text{C}$ , Duration: 250h , Recovery time: $2\text{h} \pm 0.5\text{h}$               |
| 2   | Humidity Test                | Conditions: $60^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , 90~95% RH      Duration: 250h  |
| 3   | Thermal Shock                | Heat cycle conditions: $T_A = -40^{\circ}\text{C} \pm 3^{\circ}\text{C}$ , $T_B = 85^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , $t_1 = t_2 = 30\text{min}$ , Switch time: $\leq 3\text{min}$ , Cycle time: 100 times , Recovery time : $2\text{h} \pm 0.5\text{h}$ .    |
| 4   | Vibration Fatigue            | Frequency of vibration: 10~55Hz      Amplitude: 1.5mm<br>Directions: X,Y and Z      Duration: 2h  |
| 5   | Drop Test                    | Cycle time: 10 times      Height: 1.0m  |
| 6   | Solder Ability Test          | Temperature: $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Duration: 3.0s--5.0s<br>Depth: DIP--2/3 , SMD--1/5   |
| 7   | Resistance to Soldering Heat | (1) Thickness of PCB: 1mm , Solder condition: $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ , Duration: $10 \pm 1\text{s}$<br>(2) Temperature of Soldering Iron: $350^{\circ}\text{C} \pm 10^{\circ}\text{C}$ , Duration: 3~4s ,<br>Recovery time : $2 \pm 0.5\text{h}$ |

## Recommended Reflow Soldering Diagram



## Notes

1. As a result of the particularity of inner structure of SAW products, it is easy to be breakdown by electrostatic, so we should pay attention to **ESD protect** in the test.
2. **Static voltage** between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.
3. **Ultrasonic cleaning** may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
4. Only leads of component may **be soldered**. Please avoid soldering another part of component.
5. There is a close relationship between the device's performance and **matching network**. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.